BU2725DX

GENERAL DESCRIPTION

High voltage, high-speed switching npn transistor in a plastic full-pack envelope intended for use in horizontal deflection circuits of colour television receivers. Designed to withstand V_{CES} pulses up to 1700V.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0 V$	-	1700	V
I _c	Collector current (DC)		-	12	A
I _{CM}	Collector current peak value		-	30	A
P _{tot}	Total power dissipation	T _{hs} ≤ 25 °C	-	45	W
P _{tot} V _{CEsat}	Collector-emitter saturation voltage	T _{hs} ≤ 25 °C I _C = 7.0 A; I _B = 1.75 A	-	1.0	V
I _{Csat}	Collector saturation current	f = 16 kHz	7.0	-	A
t _s	Storage time	$I_{Csat} = 7.0 \text{ A}; f = 16 \text{kHz}$	5.8	6.5	μs

PINNING - SOT399

base

collector

emitter

isolated

DESCRIPTION

PIN

1

2

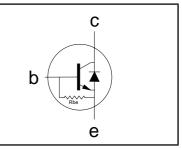
3

case

PIN CONFIGURATION

case $\bigcirc \bigcirc \circ \bigcirc \circ$





LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0 V$	-	1700	V
I _C	Collector current (DC)		-	12	A
I _{CM}	Collector current peak value		-	30	A
	Base current (DC)		-	12	A
I _{BM}	Base current peak value		-	20	A
-I _{B(AV)}	Reverse base current	average over any 20 ms period	-	200	mA
	Reverse base current peak value ¹		-	9	A
-I _{BM} P _{tot}	Total power dissipation	$T_{hs} \leq 25 \degree C$	-	45	W
T _{stg}	Storage temperature		-65	150	°C
T _j	Junction temperature		-	150	°C

ESD LIMITING VALUES

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _c	Electrostatic discharge capacitor voltage	Human body model (250 pF, 1.5 kΩ)	-	10	kV

¹ Turn-off current.

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
R _{th j-hs}	Junction to heatsink	without heatsink compound	-	3.7	K/W
R _{th j-hs}	Junction to heatsink	with heatsink compound	-	2.8	K/W
R _{th j-a}	Junction to ambient	in free air	35	-	K/W

ISOLATION LIMITING VALUE & CHARACTERISTIC

 $T_{hs} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	Repetitive peak voltage from all three terminals to external heatsink	R.H. \leq 65 % ; clean and dustfree	-	-	2500	V
C _{isol}	Capacitance from T2 to external heatsink	f = 1 MHz	-	22	-	pF

STATIC CHARACTERISTICS

 T_{hs} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CES}	Collector cut-off current ²		-	-	1.0	mA
I _{CES}		$V_{BE} = 0 V; V_{CE} = V_{CESMmax};$	-	-	2.0	mA
I _{EBO}	Emitter cut-off current	T _j = 125 °C V _{FB} = 7.5 V; I _C = 0 A	-	110	-	mA
B _{VEBO}	Emitter-base breakdown voltage	$I_{B} = 1 \text{ mA}$	7.5	13.5	-	V
R _{EB} V _{CEsat}	Base-emitter resistance	$\bar{V}_{EB} = 7.5 V$		70		Ω
V _{CEsat}	Collector-emitter saturation voltage	$ I_{c} = 7.0 \text{ A}; I_{B} = 1.75 \text{ A}$	-	-	1.0	V
V _{BEsat}	Base-emitter saturation voltage	$I_{c} = 7.0 \text{ A}; I_{B} = 1.75 \text{ A}$ $I_{c} = 7.0 \text{ A}; I_{B} = 1.75 \text{ A}$	0.78	0.86	0.95	V
V _F	Diode forward voltage	$I_{\rm F} = 7 \text{A}$		1.4	2.2	V
h _{FE}	DC current gain	$I_{c} = 1 \text{ A}; V_{cr} = 5 \text{ V}$	-	19	-	
h _{FE}	Ŭ	$I_{c} = 1 \text{ A}; V_{CE} = 5 \text{ V}$ $I_{c} = 7 \text{ A}; V_{CE} = 1 \text{ V}$	3.8	5.8	7.8	

DYNAMIC CHARACTERISTICS

 $T_{hs} = 25$ °C unless otherwise specified

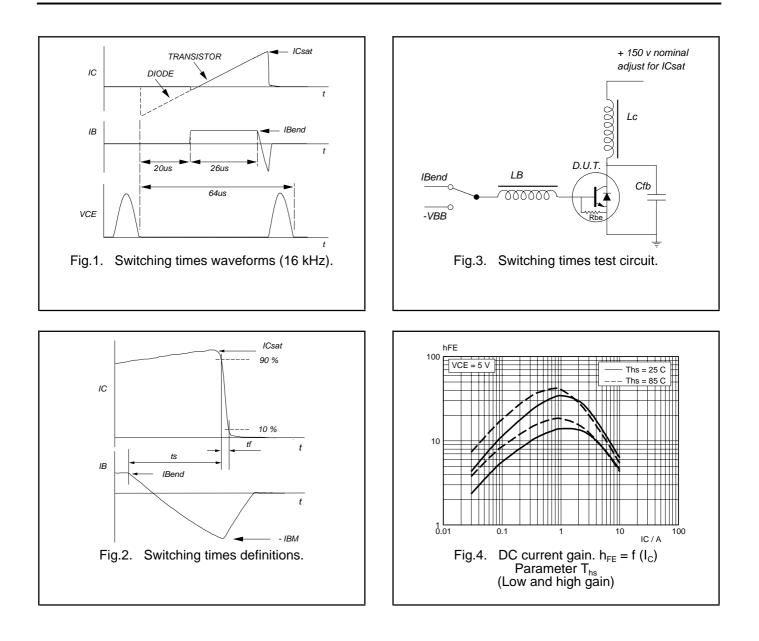
SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
	Switching times (16 kHz line deflection circuit)	$ I_{Csat} = 7.0 \text{ A}; \ L_{C} = 650 \ \mu\text{H}; \ C_{fb} = 18 \ n\text{F}; \\ V_{CC} = 162 \ \text{V}; \ I_{B(end)} = 1.5 \ \text{A}; \ L_{B} = 2 \ \mu\text{H}; \\ -V_{BB} = 4 \ \text{V} $			
t _s t _f	Turn-off storage time Turn-off fall time		5.8 0.6	6.5 0.8	μs μs

² Measured with half sine-wave voltage (curve tracer).

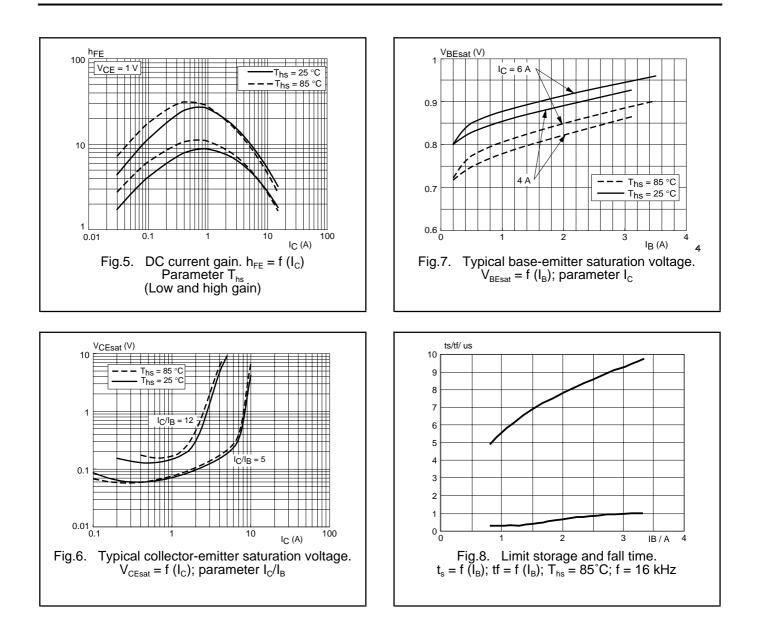
Product specification

Silicon Diffused Power Transistor

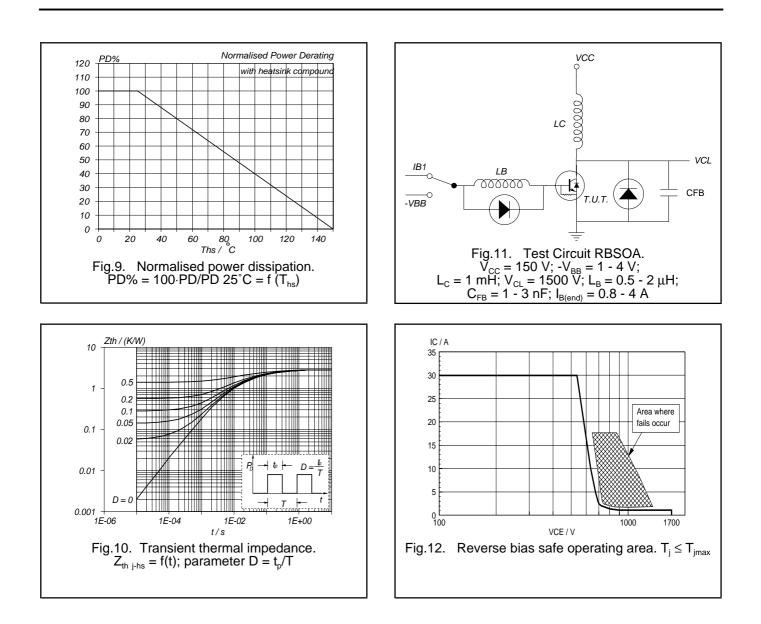
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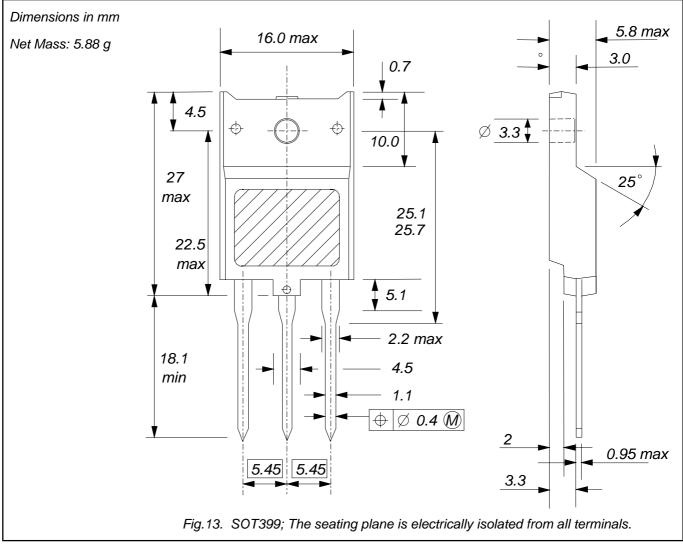


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MECHANICAL DATA



Notes

Refer to mounting instructions for F-pack envelopes.
Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

DATA SHEET STA	DATA SHEET STATUS					
DATA SHEET STATUS ³	PRODUCT STATUS⁴	DEFINITIONS				
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice				
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product				
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A				

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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